

SMT inductors

SIMID series, SIMID 1210-T

Series/Type: **B82422T**

Date: September 2019

SIMID 1210-T

SMD

Size 1210 (EIA) or 3225 (IEC)
Rated inductance 0.010 ... 100 μ H
Rated current 60 ... 450 mA


Construction

- Ceramic or ferrite core
- Laser-welded winding
- Flame-retardant molding

Features

- High Q factor
- High resonance frequency
- High L value
- Qualified to AEC-Q200
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- RoHS-compatible

Applications

- Filtering of supply voltages, coupling, decoupling
- Antenna systems
- Automotive electronics
- Telecommunications
- Consumer and data processing equipment
- Industrial electronics

Terminals

- Base material CuSn6
- Layer composition Cu, Ag, Sn (lead-free)¹⁾
- Electro-plated

Marking

- Marking on component:
Manufacturer and letter "T", L value (in μ H),
tolerance of L value (coded), date of manufacture (YWWD)
- Minimum data on reel:
Manufacturer, ordering code, L value, quantity, date of packing

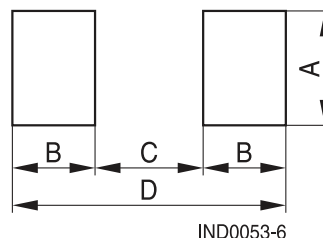
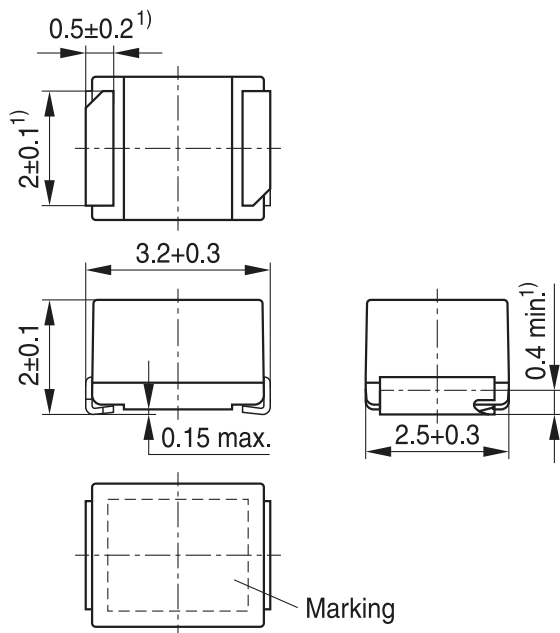
Delivery mode and packing units

- 8-mm blister tape, wound on 180-mm or 330-mm $\varnothing$ reel
- Packing units:
180-mm reel: 2000 pcs./reel
330-mm reel: 8000 pcs./reel

1) Ni-barrier-plated terminals (NiSn) on request (B82422T*50).

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Dimensional drawing and layout recommendation



A	B	C	D
2.7	1.15	2.1	4.4

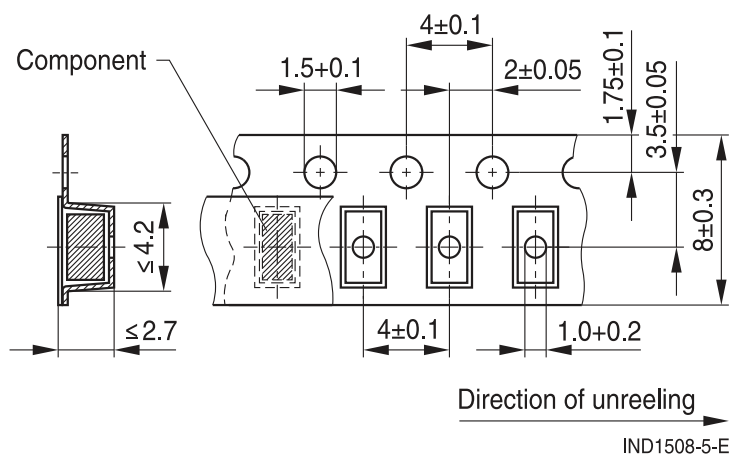
1) Soldering area

IND0073-6-E

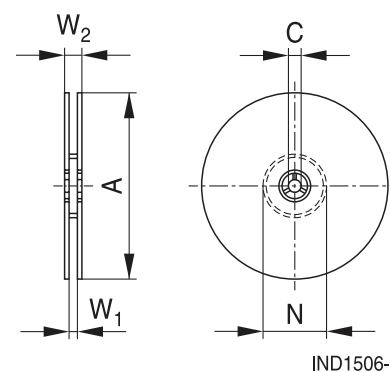
Dimensions in mm

Taping and packing

Blister tape



Reel



Dimensions in mm

	180 mm reel	330 mm reel
A	180.0 +0/-3	330.0 ± 2.0
C	13.0 +0.5/-0.2	13.0 +0.5/-0.2
N	60.0 ± 1.0	75.0 +1.0/-3.0
W ₁	8.4 +1.5/-0	8.4 +1.5/-0
W ₂	14.4 max	14.4 max

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Technical data and measuring conditions

Rated inductance L_R	Measured with impedance analyzer Agilent 4294A or equivalent at frequency f_L , 0.1 V, +20 °C
Q factor Q_{min}	Measured with impedance analyzer Agilent 4294A or equivalent at frequency f_Q , +20 °C
Rated temperature T_R	+85 °C
Rated current I_R	Maximum permissible DC with inductance decrease $\Delta L/L_0 \leq 10\%$ and temperature increase of ≤ 30 K at rated temperature
Self-resonance frequency $f_{res,min}$	Measured with impedance analyzer Agilent E4991 / network analyzer Agilent E8362B or equivalent, +20 °C
DC resistance R_{max}	Measured at +20 °C
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: +(245 ±5) °C, (5 ±0.3) s Wetting of soldering area $\geq 90\%$ (based on IEC 60068-2-58)
Resistance to soldering heat	+260 °C, 40 s (as referenced in JEDEC J-STD 020D)
Climatic category	55/125/56 (to IEC 60068-1)
Storage conditions	Mounted: -55 °C ... +125 °C Packaged: -25 °C ... +40 °C, $\leq 75\%$ RH
Weight	Approx. 50 mg

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Characteristics and ordering codes

L_R μH	Tolerance	$Q_{\min}$	$f_L; f_Q$ MHz	I_R mA	$R_{\max}$ Ω	$f_{\text{res},\min}$ MHz	Ordering code ¹⁾²⁾ ($\varnothing$ 180-mm reel)
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Core material: ceramic

0.010	$\pm 5\% \triangle J$	15	100	450	0.10	4000	B82422T3100+000
0.012	$\pm 10\% \triangle K$	17	100	450	0.11	3500	B82422T3120+000
0.015		19	100	450	0.13	3000	B82422T3150+000
0.018		21	100	450	0.14	2000	B82422T3180+000
0.022		23	100	450	0.16	2000	B82422T3220+000
0.027		23	100	450	0.17	1700	B82422T3270+000
0.033		25	100	450	0.18	1700	B82422T3330+000
0.039		25	100	450	0.19	1300	B82422T3390+000
0.047		26	100	450	0.20	1300	B82422T3470+000
0.056		26	100	450	0.21	1100	B82422T3560+000
0.068		27	100	450	0.23	1000	B82422T3680+000
0.082		27	100	450	0.26	1000	B82422T3820+000
0.10		28	100	450	0.31	900	B82422T3101+000

Core material: ferrite

0.12	$\pm 5\% \triangle J$	30	25.2	450	0.15	900	B82422T1121+000
0.15	$\pm 10\% \triangle K$	30	25.2	450	0.18	700	B82422T1151+000
0.18		30	25.2	450	0.19	500	B82422T1181+000
0.22		30	25.2	450	0.20	500	B82422T1221+000
0.27		30	25.2	450	0.21	500	B82422T1271+000
0.33		30	25.2	450	0.23	500	B82422T1331+000
0.39		30	25.2	450	0.25	400	B82422T1391+000
0.47		30	25.2	450	0.30	400	B82422T1471+000
0.56		30	25.2	450	0.31	300	B82422T1561+000
0.68		30	25.2	450	0.34	300	B82422T1681+000
0.82		30	25.2	450	0.38	300	B82422T1821+000
1.0		30	7.96	400	0.6	300	B82422T1102+000
1.2		30	7.96	390	0.7	250	B82422T1122+000

Closer tolerances and special versions on request.

Higher currents possible at temperatures $<T_R$ on request.

Sample kit available. Ordering code: B82422X001

For more information refer to chapter "Sample kits".

1) Replace the + by the code letter for the required inductance tolerance.

For reel size $\varnothing$ 330 mm the last digit has to be an »8«. Example: B82422T3100K008

2) For Ni-barrier-plated terminals replace the last two digits "00" by "50" (reel 180 mm) or "58" (reel 330 mm).

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Characteristics and ordering codes

L_R μH	Tolerance	$Q_{\min}$	$f_L; f_Q$ MHz	I_R mA	$R_{\max}$ Ω	$f_{\text{res},\min}$ MHz	Ordering code ¹⁾²⁾ ($\varnothing$ 180-mm reel)
1.5	$\pm 5\% \triangle J$	30	7.96	370	0.7	200	B82422T1152+000
1.8	$\pm 10\% \triangle K$	30	7.96	350	0.8	140	B82422T1182+000
2.2		30	7.96	320	0.8	100	B82422T1222+000
2.7		30	7.96	290	0.9	70	B82422T1272+000
3.3		30	7.96	260	1.2	60	B82422T1332+000
3.9		30	7.96	250	1.3	60	B82422T1392+000
4.7		30	7.96	220	1.5	50	B82422T1472+000
5.6		27	7.96	200	1.6	45	B82422T1562+000
6.8		27	7.96	180	1.8	40	B82422T1682+000
8.2		27	7.96	170	2.0	35	B82422T1822+000
10		27	2.52	150	2.1	30	B82422T1103+000
12		27	2.52	140	2.5	25	B82422T1123+000
15		27	2.52	130	2.8	20	B82422T1153+000
18		27	2.52	120	3.0	20	B82422T1183+000
22		27	2.52	110	3.5	20	B82422T1223+000
27		27	2.52	80	4.5	20	B82422T1273+000
33		27	2.52	70	5.6	17	B82422T1333+000
39		27	2.52	65	6.4	16	B82422T1393+000
47		27	2.52	60	7.0	15	B82422T1473+000
56		27	2.52	60	8.0	12	B82422T1563+000
68		27	2.52	60	9.0	9	B82422T1683+000
82		25	2.52	60	10	9	B82422T1823+000
100		20	0.796	60	11	8	B82422T1104+000

Closer tolerances and special versions on request.

Higher currents possible at temperatures $<T_R$ on request.

Sample kit available. Ordering code: B82422X001

For more information refer to chapter "Sample kits".

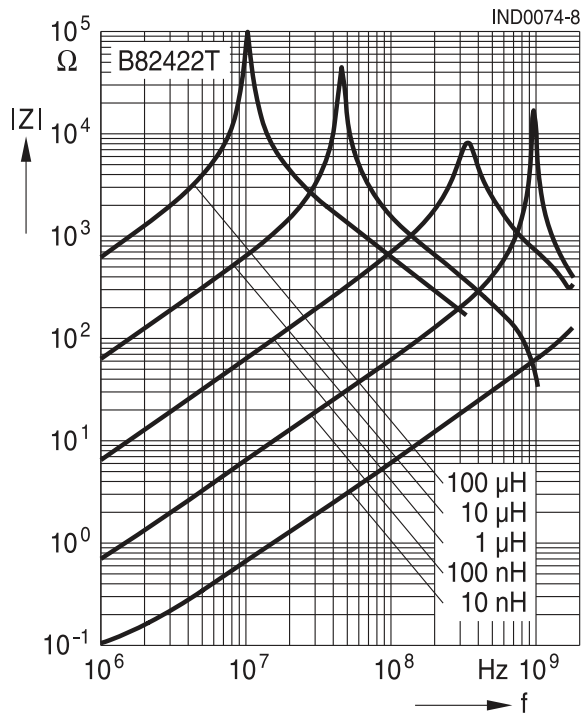
1) Replace the + by the code letter for the required inductance tolerance.

For reel size $\varnothing$ 330 mm the last digit has to be an »8«. Example: B82422T1104K008

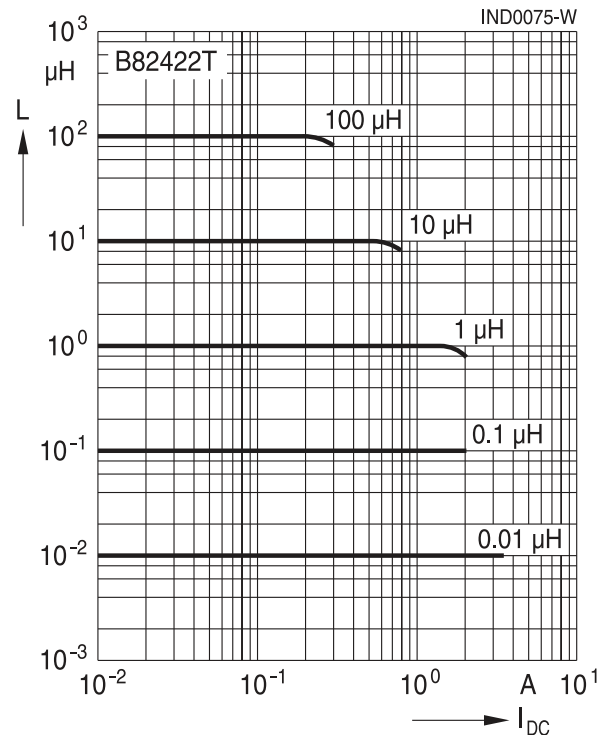
2) For Ni-barrier-plated terminals replace the last two digits "00" by "50" (reel 180 mm) or "58" (reel 330 mm).

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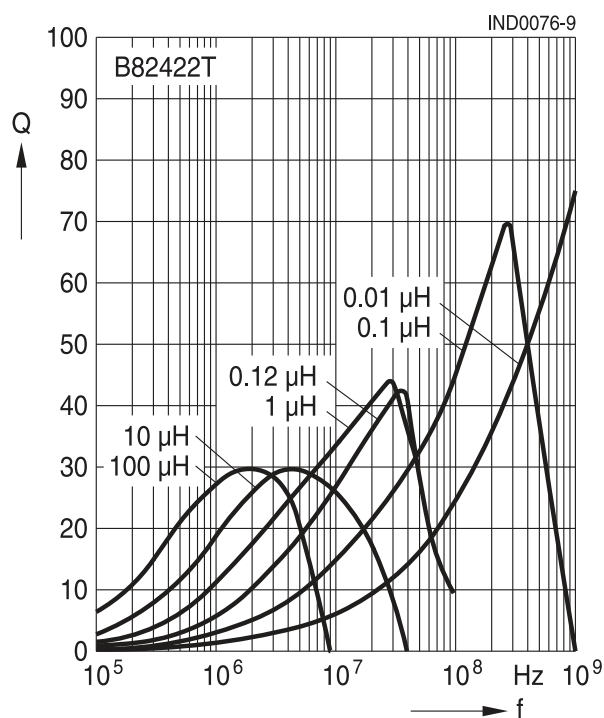
Impedance $|Z|$ versus frequency f
measured with impedance analyzer
Agilent E4991A, typical values at +20 °C



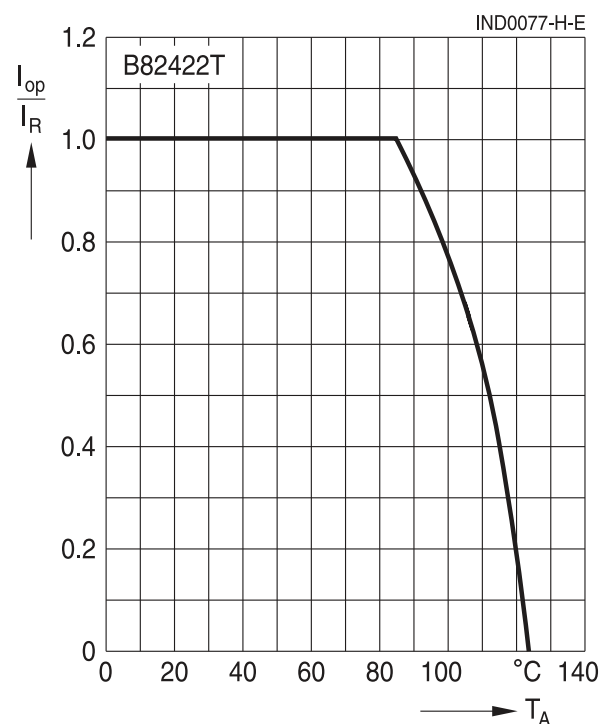
Inductance L versus DC load current I_{DC}
measured with LCR meter Agilent 4285A,
typical values at +20 °C



Q factor versus frequency f
measured with impedance analyzer Agilent
4294A/E4991A, typical values at +20 °C



Current derating I_{op}/I_R
versus ambient temperature T_A
(rated temperature $T_R = +85$ °C)



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire, wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obligated to determine whether and to what extent their coating materials influence the component.

Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Ceramics / ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.** Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

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The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
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We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
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Important notes

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The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System**. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
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Release 2018-10

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[B82422T3470K](#) [B82422X1](#) [B82422T1122K8](#) [B82422T1223K8](#) [B82422T1152K8](#) [B82422T1102K8](#) [B82422T1222K8](#)
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[B82422T1681K8](#) [B82422T1121K8](#) [B82422T1224K000](#) [B82422T1274K000](#) [B82422T1334K000](#) [B82422T1124K000](#)
[B82422T1154K000](#) [B82422T3350J000](#) [B82422T1154K008](#) [B82422T1184K000](#)



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Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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